

SiC Schottky Barrier Diode

TRS12N65FB

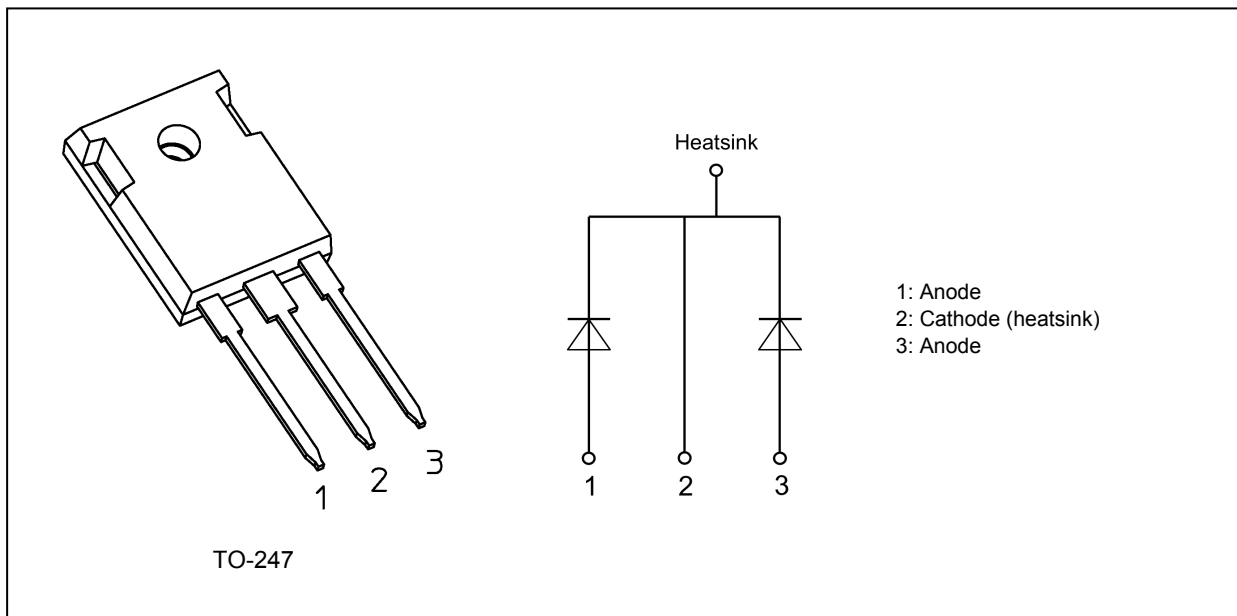
1. Applications

- Power Factor Correction
- Solar Inverters
- Uninterruptible Power Supplies
- DC-DC Converters

2. Features

- (1) Chip design of 2nd generation
- (2) High non-repetitive peak forward surge current: I_{FSM} (Per Leg) / (Both Legs) = 52 A / 104 A
- (3) Low junction capacitance: C_j (Per Leg) = 23 pF (typ.)
- (4) Low reverse current: I_R (Per Leg) = 0.3 μ A (typ.)

3. Packaging and Internal Circuit



Start of commercial production
2020-07

4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}			650	V
Forward DC current	$I_{F(DC)}$		Per Leg	6	A
			Both Legs	12	
Forward pulse current	I_{FP}	(Note 1)	Per Leg	60	
			Both Legs	120	
Power dissipation	P_D	(Note 2)	Per Leg	68	W
			Both Legs	136	
Non-repetitive peak forward surge current	I_{FSM}	(Note 3)	Per Leg	52	A
			Both Legs	104	
Junction temperature	T_j			175	°C
Storage temperature	T_{stg}			-55 to 175	
Mounting torque	TOR			0.8	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $t = 50 \mu s$

Note 2: $T_c = 25 \text{ }^\circ\text{C}$

Note 3: $f = 50 \text{ Hz}$ (half-sine wave, $t = 10 \text{ ms}$)

5. Thermal Characteristics

Characteristics	Symbol	Note	Test Condition	Max	Unit
Thermal resistance (junction-to-case)	$R_{th(j-c)}$	(Note 1)	Per Leg	2.2	°C/W
			Both Legs	1.1	
Thermal resistance (junction-to-ambient)	$R_{th(j-a)}$	(Note 2)	—	50	

Note 1: $T_c = 25 \text{ }^\circ\text{C}$

Note 2: $T_a = 25 \text{ }^\circ\text{C}$

6. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C) (Per Leg)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Forward voltage (pulse measurement)	V_F	$I_F = 3 \text{ A}$	—	1.2	—	V
		$I_F = 6 \text{ A}$	—	1.45	1.6	
Reverse current (pulse measurement)	I_R	$V_R = 650 \text{ V}$	—	0.3	30	μA
Junction capacitance	C_j	$V_R = 400 \text{ V}$, $f = 1 \text{ MHz}$	—	23	—	pF
Total junction capacitive charge	Q_{cj}	$V_R = 0.1 \text{ to } 400 \text{ V}$	—	15	—	nC

7. Marking (Note)

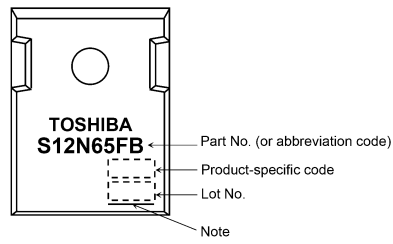


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Abbreviation Code	Part Number
S12N65FB	TRS12N65FB

8. Characteristics Curves (Note)

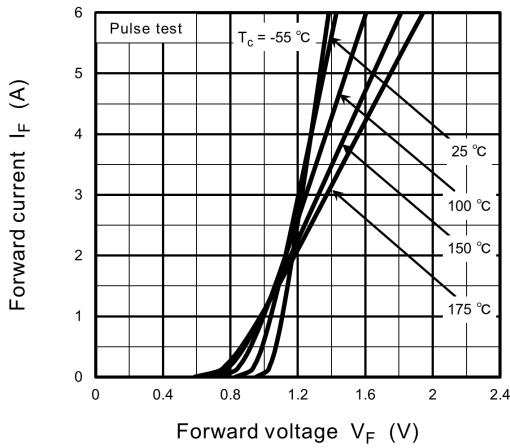


Fig. 8.1 $I_F - V_F$ (Per Leg)

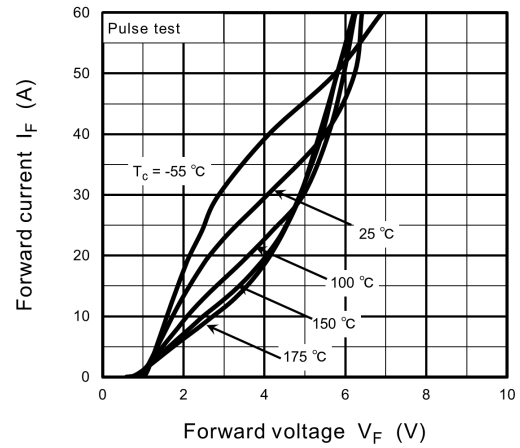


Fig. 8.2 $I_F - V_F$ (Per Leg)

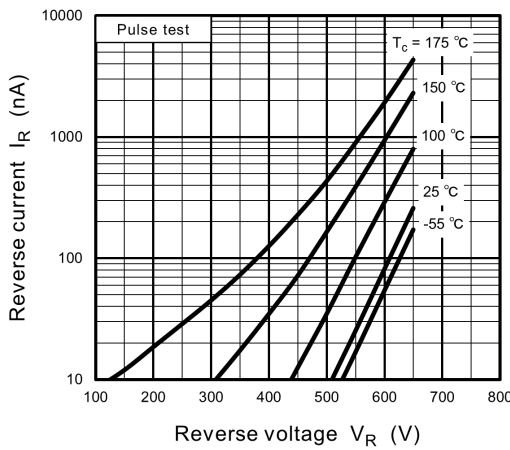


Fig. 8.3 $I_R - V_R$ (Per Leg)

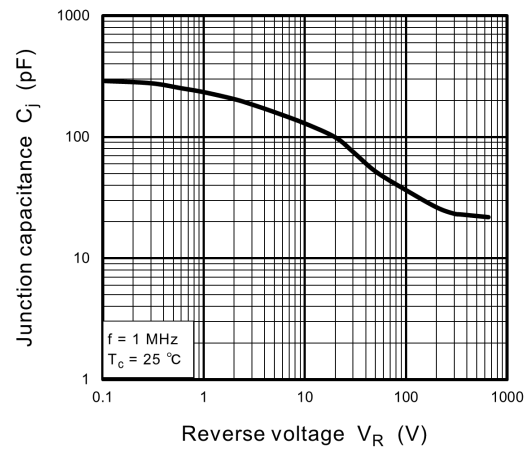


Fig. 8.4 $C_j - V_R$ (Per Leg)

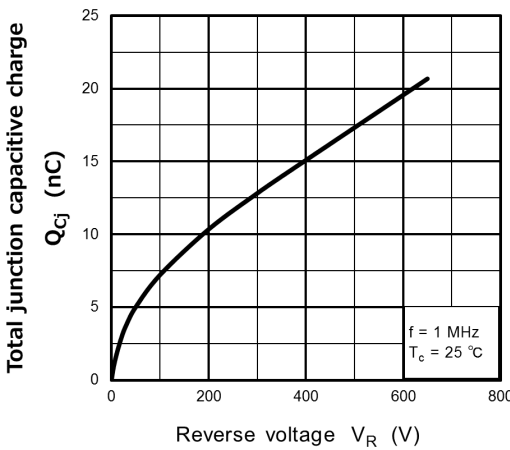
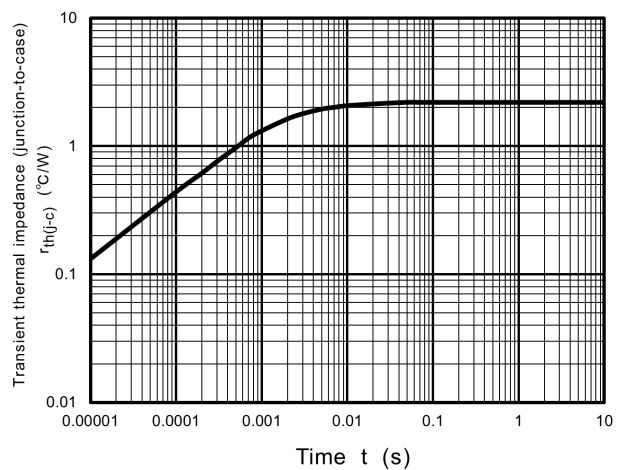


Fig. 8.5 $Q_{cj} - V_R$



**Fig. 8.6 $r_{th(j-c)} - t$
(Guaranteed Maximum) (Per Leg)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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